

We focus on power.

Version 0.90

2009-06-24

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TAPERED AMPLIFIER

GaAs Semiconductor Laser Diode



General Product Information

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Absolute Maximum Ratings

	Symbol	Unit	min	typ	max
Storage Temperature	T _S	°C	-40		85
Operational Temperature at Case	T_{C}	°C	0		50
Forward Current	I_{F}	А			1.7
Reverse Voltage	V_R	V			0
Output Power	P_{opt}	W			0.6

non condensing

non condensing

Stress in excess of the Absolute Maximum Ratings can cause permanent damage to the device. Operation at the Absolute Maximum Rating for extended periods of time can adversely affect the device realibility and may lead to reduced operational life.

Recommended Operational Conditions

Symbol	Unit	min	typ	max
T _C	°C	5		40
I _F	Α			1.5
P _{input}	mW	10		50
P_{opt}	W			0.5
	T _C I _F P _{input}	T _C °C I _F A P _{input} mW	T_{C} °C 5 I_{F} A P_{input} mW 10	T_{C} °C 5 I_{F} A P_{input} mW 10

Measurement Conditions / Comments
non condensing
with proper injection from a seed laser

Characteristics at T_{LD} = 25 °C at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Center Wavelength	λ_{C}	nm	840	850	860
Gain Width (FWHM)	Δλ	nm		30	
Temperature Coefficient of Wavelength	$d\lambda$ / dT	nm / K		0.3	
Amplification	P _{opt}	dB		10	
Operational Current @ $P_{opt} = 0.5 W$	I _{op Gain}	А			1.5
Output Power @ I _F = 1.5 A	P _{opt}	W	0.5		
Cavity Length	L	μm		2750	

Measurement Conditions / Comments
see images on page 4
with proper injection from a seed laser





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Characteristics at T _{amb}					cont'd	
Parameter	Symbol	Unit	min	typ	max	Measurement Conditions / Comments
Input Aperture (at rear side)	d_{input}	μm		3		
Output Aperture (at front side)	d_{output}	μm		190		
Astigmatism	А	μm	500	600	700	depending on operating conditions
Divergence parallel (FWHM)	$\Theta_{ }$	0		14		
Divergence perpendicular (FWHM)	Θ_{\perp}	0		28		
Polarization				TE		E field parallel to junction plane



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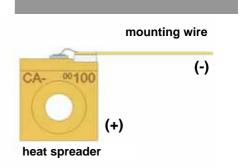
Package Dimensions

Parameter	Symbol	Unit	min	typ	max
Height of Emission Plane	h	mm	7.05	7.20	7.35
C-Mount Thickness	t	mm		2.75	

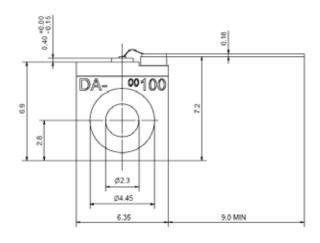
Measurement Conditions / Comments	

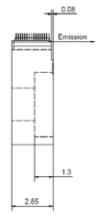
Package Pinout

Cathode (-)	Mounting Wire
Anode (+)	Housing



Package Drawings





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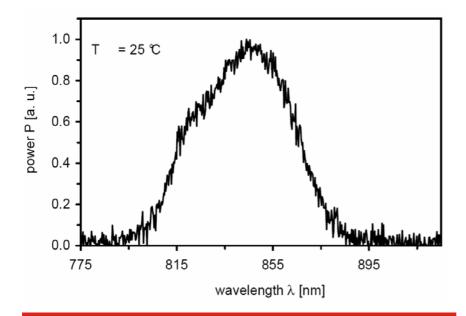
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Typical Measurement Results

Spectrum measured w/o injection:



Performance figures, data and any illustrative material provided in this specification are typical and must be specifically confirmed in writing by eagleyard Photonics before they become applicable to any particular order or contract. In accordance with the eagleyard Photonics policy of continuous improvement specifications may change without notice.

Ordering Information:



800 Village Walk #316 Guilford, CT 06437 Ph: 203-401-8093

Email orders to: sales@xsoptix.com Fax orders to: 800-878-7282

Unpacking, Installation and Laser Safety

Unpacking the laser diodes should only be done at electrostatic safe workstations (EPA). Though protection against electro static discharge (ESD) is implemented in the laser package, charges may occur at surfaces. Please store this product in its original package at a dry, clean place until final use. During device installation, ESD protection has to be maintained.

The TPA diode type is known to be sensitive against thermal stress. It should not be operated without appropriate injection from a seed laser. Operating at moderate temperatures on propper heat sinks willl contribute to a long lifetime of the diode.

The laser emission from this diode is close to the invisible infrared region of the electromagnetic spectrum. Avoid direct and/or indirect exposure to the free running beam. Collimating the free running beam with optics as common in optical instruments will increase threat to the human eye.

Each laser diode will come with an individual test protocol verifying the parameters given in this document.















